onsemi

MOSFET – N-Channel, SUPERFET[®] II, FRFET[®]

600 V, 76 A, 41 m Ω

FCH041N60F

Description

SUPERFET II MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SUPERFET II FRFET MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.

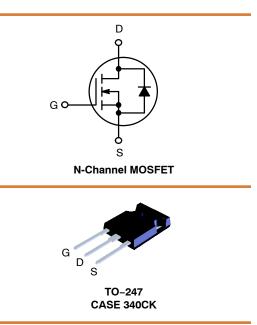
Features

- $650 \text{ V} @ \text{T}_{\text{J}} = 150^{\circ}\text{C}$
- Typ. $R_{DS(on)} = 36 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 277 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 748 pF)
- 100% Avalanche Tested
- This Device is Pb-Free, Halide Free, and is RoHS Compliant

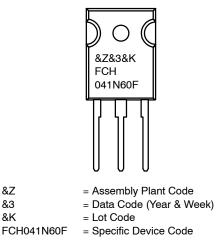
Applications

- Telecom / Server Power Supplies
- Industrial Power Supplies
- EV Charger
- UPS / Solar

V _{DSS}	R _{DS(ON)} MAX	I _D MAX		
600 V	41 m Ω	76 A		



MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	Value	Unit		
V _{DSS}	Drain to Source Voltage		600	V	
V _{GSS}	Gate to Source Voltage	DC	±20	V	
		AC (f > 1 Hz)	±30		
۱ _D	Drain Current	Continuous (T _C = 25°C)	76	А	
		Continuous (T _C = 100°C)	48.1		
I _{DM}	Drain Current	Pulsed (Note 1)	228	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		2025	mJ	
I _{AR}	Avalanche Current (Note 1)		15	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)		5.95	mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)		50		
P _D	Power Dissipation	(T _C = 25°C)	595	W	
		Derate Above 25°C	4.76	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 s		300	°C	

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 15 \text{ A}, \text{ R}_{G} = 25 \Omega$, starting $T_{J} = 25^{\circ}\text{C}$. 3. $I_{SD} \leq 38 \text{ A}, \text{ di/dt} \leq 200 \text{ A/}\mu\text{s}, \text{ V}_{DD} \leq 380 \text{ V}$, starting $T_{J} = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.21	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH041N60F	FCH041N60F	TO-247	Tube	N/A	N/A	30 Units

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_{D} = 10 mA, T_{J} = 25°C	600	-	-	V
		V_{GS} = 0 V, I_{D} = 10 mA, T_{J} = 150°C	650	-	-	
$\Delta \text{BV}_{\text{DSS}}\!/\!\Delta\text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	I_D = 10 mA, Referenced to 25°C	-	0.67	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	10	μA
		V_{DS} = 480 V, T_{C} = 125°C	-	267	-	
I _{GSS}	Gate to Body Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V	-	-	±100	nA
ON CHARACTE	RISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	3	-	5	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 38 A	-	36	41	mΩ
9 _{FS}	Forward Transconductance	V _{DS} = 20 V, I _D = 38 A	-	64.5	-	S
YNAMIC CHA	RACTERISTICS	-				
C _{iss}	Input Capacitance	V_{DS} = 100 V, V_{GS} = 0 V, f = 1 MHz	-	10800	14365	pF
Coss	Output Capacitance	-	-	324	430	pF
C _{rss}	Reverse Transfer Capacitance		-	4.5	-	pF
Coss	Output Capacitance	V_{DS} = 380 V, V_{GS} = 0 V, f = 1 MHz	-	185	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 480 V, V_{GS} = 0 V	-	748	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 380 \text{ V}, I_D = 38 \text{ A}, V_{GS} = 10 \text{ V}$ (Note 4)	-	277	360	nC
Q _{gs}	Gate to Source Gate Charge		-	65.3	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	116	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	1.0	-	Ω
	IARACTERISTICS	-				
t _{d(on)}	Turn-On Delay Time	V _{DD} = 380 V, I _D = 38 A,	-	63	136	ns
t _r	Turn-On Rise Time	V _{GS} = 10 V, R _G = 4.7 Ω (Note 4)	-	66	142	ns
t _{d(off)}	Turn-Off Delay Time		-	244	498	ns
t _f	Turn-Off Fall Time		-	53	116	ns
OURCE-DRAI	N DIODE CHARACTERISTICS	•				
۱ _S	Maximum Continuous Source to Drain Diode Forward Current			-	77	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	231	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 38 A	_	-	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 38 A,	-	214	-	ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/μs	-	1.79	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

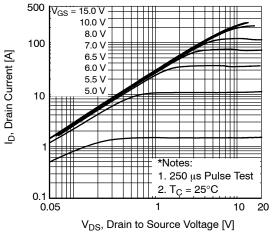


Figure 1. On-Region Characteristics

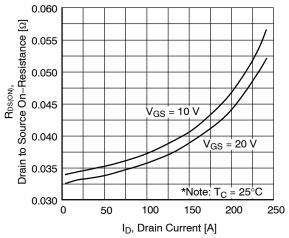
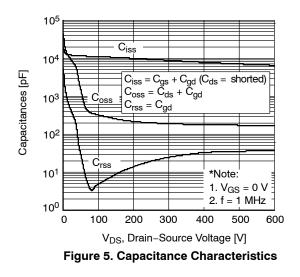


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage



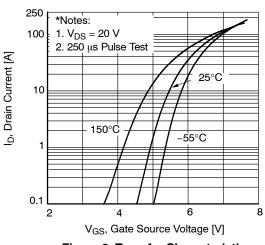


Figure 2. Transfer Characteristics

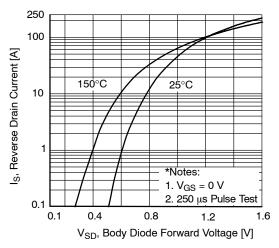
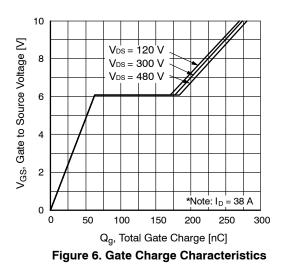
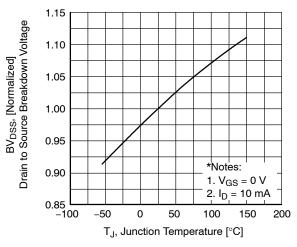
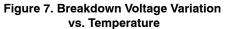


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature



TYPICAL PERFORMANCE CHARACTERISTICS (continued)





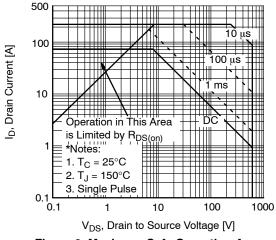


Figure 9. Maximum Safe Operation Area

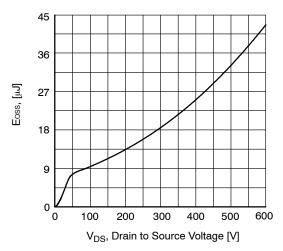


Figure 11. E_{OSS} vs. Drain to Source Voltage

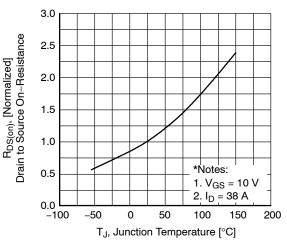
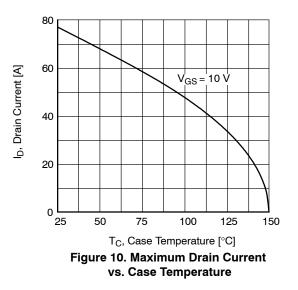


Figure 8. On-Resistance Variation vs. Temperature



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

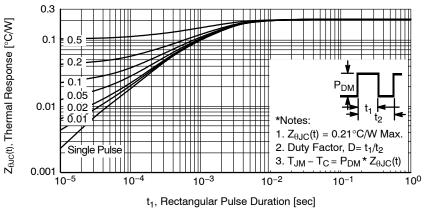
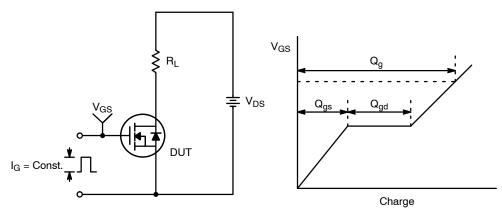


Figure 12. Transient Thermal Response Curve





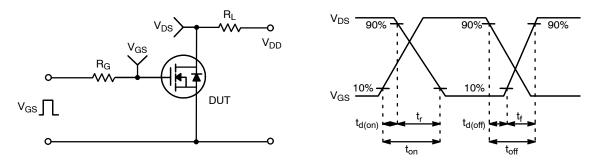


Figure 14. Resistive Switching Test Circuit & Waveforms

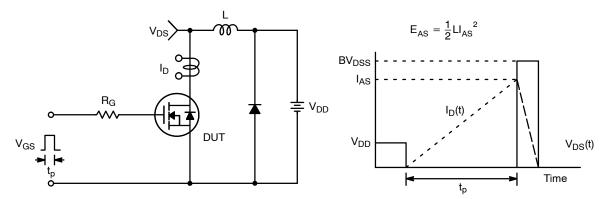


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

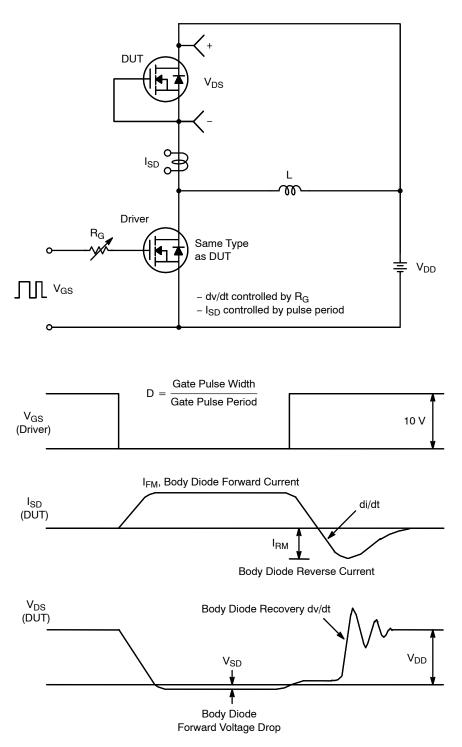


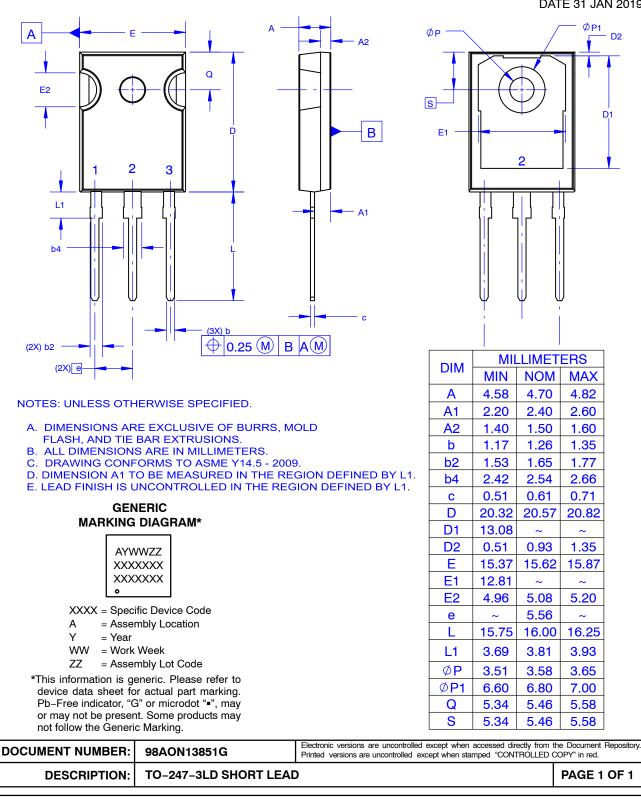
Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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TO-247-3LD SHORT LEAD CASE 340CK **ISSUE A**

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